

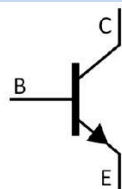
/ Descriptions

SOT-23 NPN

/ Features

/ Applications

/ Equivalent Circuit



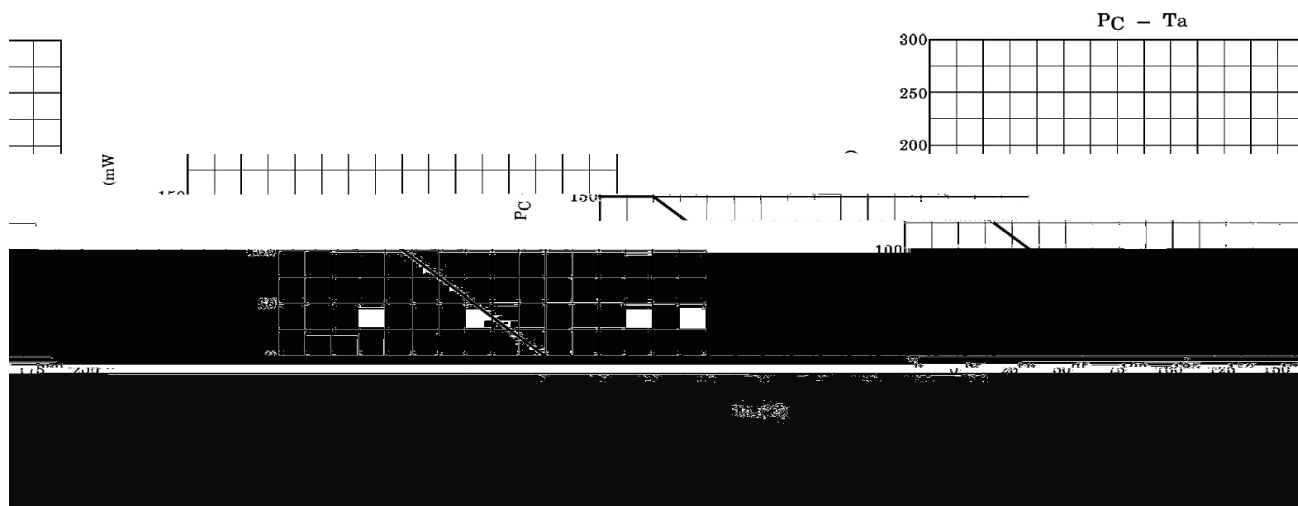
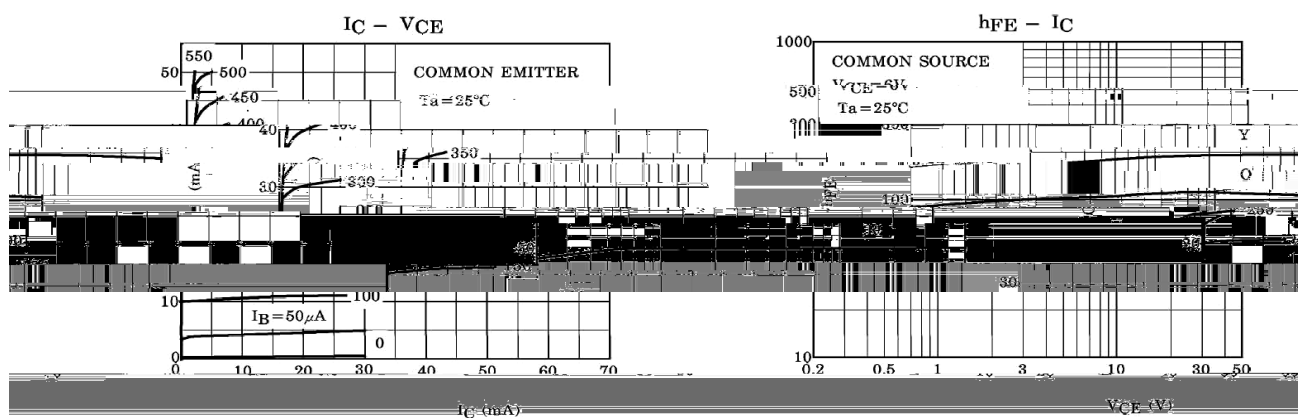
/ Pinning



/ h_{FE} Classifications & Marking

						μ
						μ

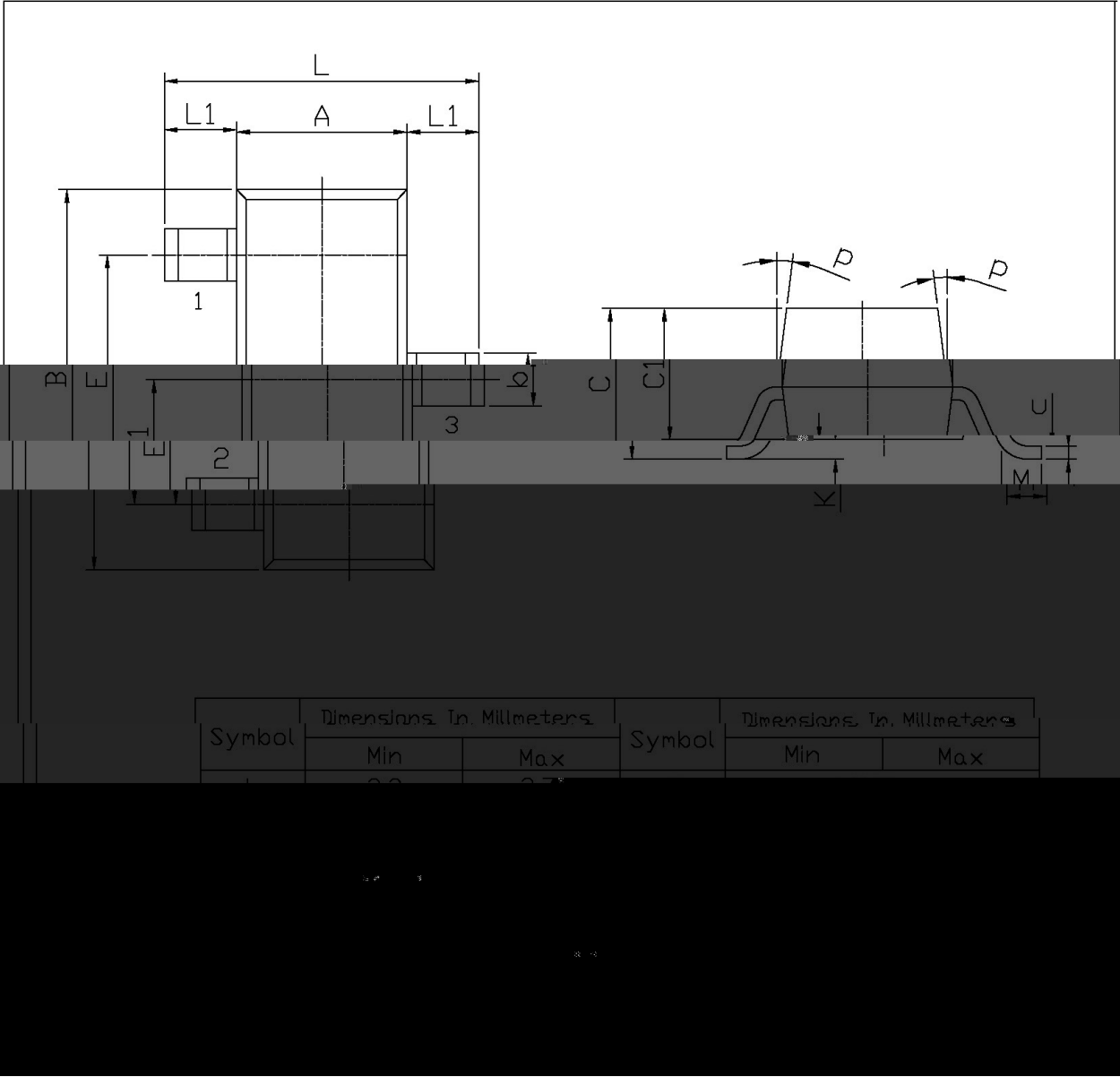
/ Electrical Characteristic Curve



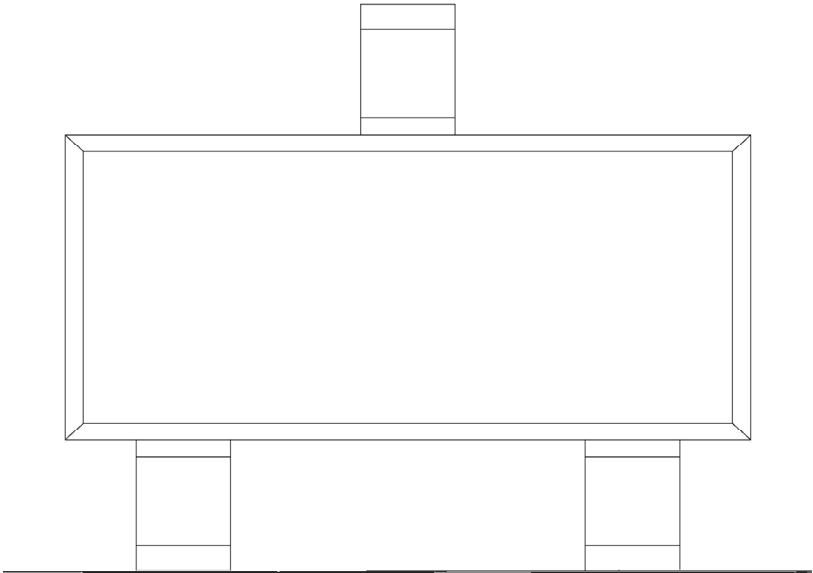
/ Package Dimensions

SOT-23

单位：mm

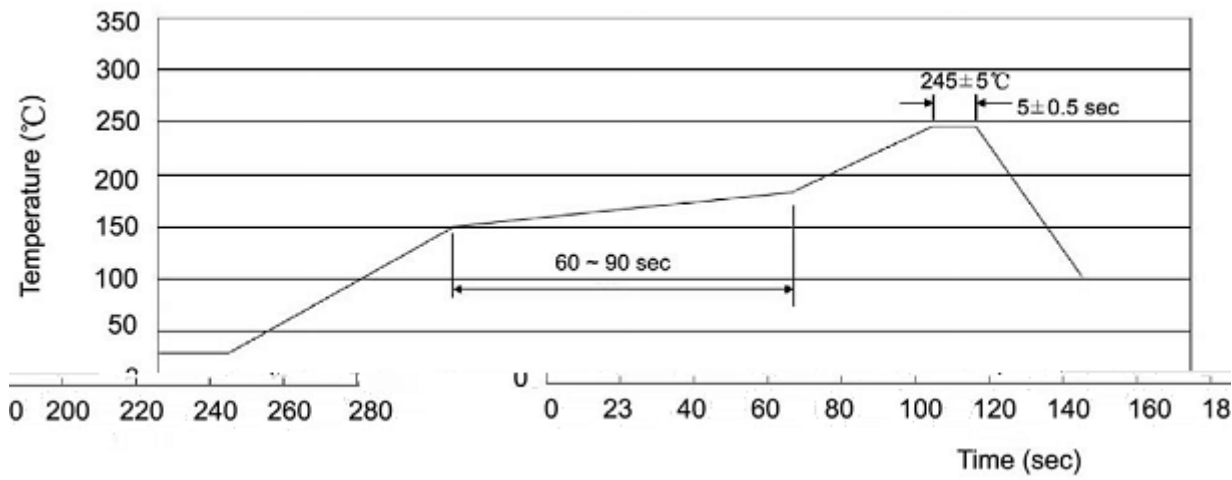


/ Marking Instructions



H	
R	
R	h_{FE}
H	
R	

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± ± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸		
	只 卷盘	卷盘 盒	只 盒	盒 箱	只 箱		盒	箱

/ Notices